



### **DUAL SURFACE-MOUNT SWITCHING DIODE**

### **Features**

- Fast Switching Speed: Maximum of 4ns
- Low Capacitance: Maximum of 2.0pF
- Small Surface-Mount Package
- For General-Purpose Switching Applications
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The BAV70WQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

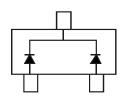
## **Mechanical Data**

- Package: SOT323
- Package Material: Molded Plastic, "Green" Molding Compound;
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208
   Lead Free Plating (Matte Tin Finish Annealed over Alloy 42
   Leadframe) (3)
- Polarity: See Diagram
- Weight: 0.006 grams (Approximate)





Top View



Top View Internal Schematic

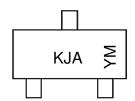
## Ordering Information (Notes 4 & 5)

Part Number	hor Bookege		Packing		
Fait Number	Package	Qty.	Carrier		
BAV70W-7-F	SOT323	3000	Tape & Reel		
BAV70WQ-7-F	SOT323	3000	Tape & Reel		

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.
- 5. Product manufactured with Date Code 0627 (week 27, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0627 are built with Non-Green Molding Compound and may contain Halogens or Sb<sub>2</sub>O<sub>3</sub> Fire Retardants.

## **Marking Information**



KJA = Product Type Marking Code

YM = Date Code Marking

Y = Year (ex: K = 2023; A Bar on Top of the "Y = Year" Denotes AT Site)

M = Month (ex: 5 = May)

Date Code Key

Year	2000		2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	L		K	L	М	N	Р	R	S	T	U	V
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code		•	•		_	_	_	_	_	_	N	



## **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage	$V_{RM}$	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	VRRM VRWM VR	75	V
RMS Reverse Voltage	V <sub>R</sub> (RMS)	53	V
Forward Continuous Current (Note 6)	I <sub>FM</sub>	300	mA
Non-Repetitive Peak Forward Surge Current (Note 6) @ t = 1.0µs @ t = 1.0s	IFSM	2.0 1.0	А

## **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	PD	200	mW
Thermal Resistance Junction to Ambient Air (Note 6)	$R_{ heta JA}$	625	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

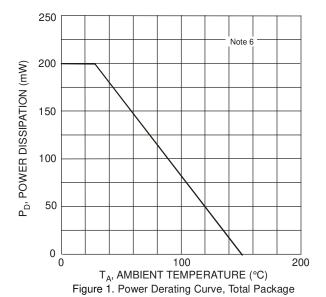
# Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

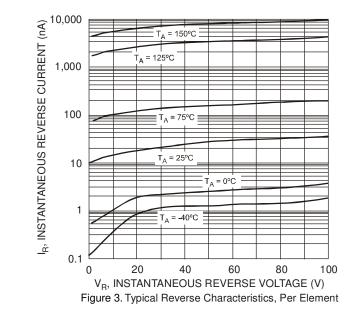
Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	75		V	$I_R = 100 \mu A$
Forward Voltage	VF		0.715 0.855 1.0 1.25	٧	IF = 1.0mA IF = 10mA IF = 50mA IF = 150mA
Reverse Current (Note 7)	IR		2.5 50 30 25	μΑ μΑ μΑ nA	VR = 75V VR = 75V, TJ = +150°C VR = 25V, TJ = +150°C VR = 20V
Total Capacitance	Ст	_	2.0	pF	V <sub>R</sub> = 0, f = 1.0MHz
Reverse-Recovery Time	t <sub>rr</sub>	_	4.0	ns	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100 \Omega$

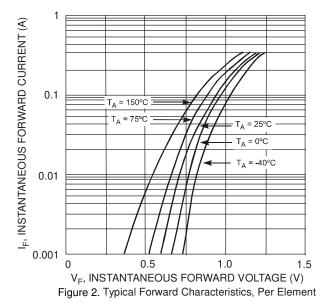
Notes:

<sup>6.</sup> Device mounted on a 2"  $\times$  2" Al board. 7. Short duration pulse test used to minimize self-heating effect.









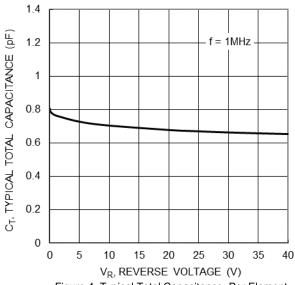


Figure 4. Typical Total Capacitance, Per Element

Note: 6. Device mou

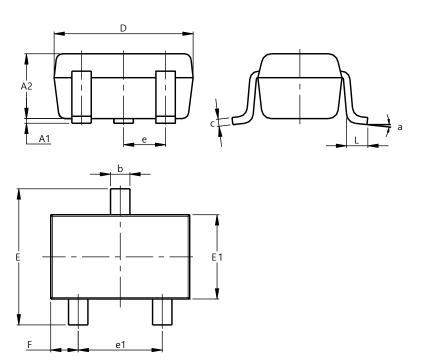
6. Device mounted on a 2" × 2" Al board.



# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### **SOT323**

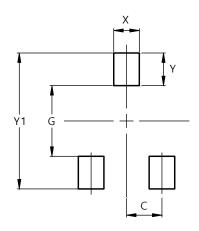


SOT323						
Dim	Min	Max	Тур			
A1	0.00	0.10	0.05			
A2	0.90	1.00	0.95			
b	0.25	0.40	0.30			
С	0.10	0.18	0.11			
D	1.80	2.20	2.15			
Е	2.00	2.20	2.10			
E1	1.15	1.35	1.30			
е	0.650 BSC					
e1	1.20	1.40	1.30			
F	0.375	0.475	0.425			
L	0.25	0.40	0.30			
а	0°	8°				
All	All Dimensions in mm					

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### SOT323



Dimensions	Value (in mm)		
С	0.650		
G	1.300		
Х	0.470		
Υ	0.600		
Y1	2.500		



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